N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY			
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)	Q_g (Typ.)
30	0.0042 at V_{GS} = 10 V	25	27
	0.0057 at V_{GS} = 4.5 V	22	

FEATURES

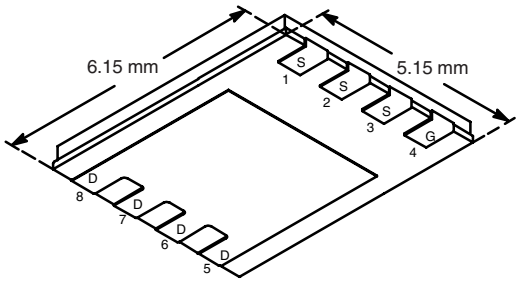
- **Halogen-free available**
- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK® Package with Low 1.07 mm Profile
- Low Gate Charge
- 100 % R_g Tested

RoHS COMPLIANT

APPLICATIONS

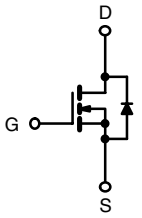
- Synchronous Rectifier

PowerPAK SO-8



Bottom View

Ordering Information: Si7892BDP-T1-E3 (Lead (Pb)-free)
Si7892BDP-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted					
Parameter		**Symbol**	**10 s**	**Steady State**	**Unit**
Drain-Source Voltage		V_{DS}	30		V
Gate-Source Voltage		V_{GS}	± 20		
Continuous Drain Current (T_J = 150°C)[a]	T_A = 25 °C	I_D	25	15	A
	T_A = 70 °C		20	12	
Pulsed Drain Current (10 µs Pulse Width)		I_{DM}	60		
Continuous Source Current (Diode Conduction)[a]		I_S	4.1	1.5	
Avalanche Current	L = 0.1 mH	I_{AS}	40		
Single Pulse Avalanche Energy		E_{AS}	80		mJ
Maximum Power Dissipation[a]	T_A = 25 °C	P_D	5	1.8	W
	T_A = 70 °C		3.2	1.1	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature)[b, c]			260		

THERMAL RESISTANCE RATINGS					
Parameter		**Symbol**	**Typical**	**Maximum**	**Unit**
Maximum Junction-to-Ambient[a]	t ≤ 10 s	R_{thJA}	20	25	°C/W
	Steady State		53	70	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	2.1	3.2	

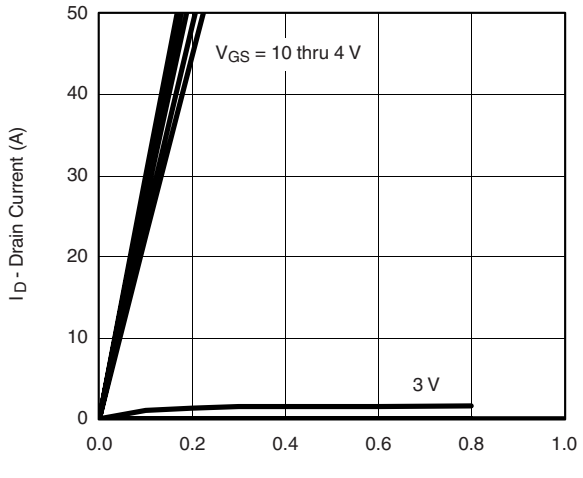
Notes:
a. Surface Mounted on 1" x 1" FR4 board.
b. See Solder Profile (*http://www.vishay.com/ppg?73257*). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

SPECIFICATIONS T_J = 25 °C, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Static						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	1.0		3.0	V
V_{DS} Temperature Coefficient	$\Delta V_{DS/Tj}$	I_D = 250 µA		28		mV/°C
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)/Tj}$			- 6.5		
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ±20 V			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 30 V, V_{GS} = 0 V			1	µA
		V_{DS} = 30 V, V_{GS} = 0 V, T_J = 55°C			5	
On-State Drain Current[a]	$I_{D(on)}$	$V_{DS} \geq$ 5 V, V_{GS} = 10 V	30			A
Drain-Source On-State Resistance[a]	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 25 A		0.0034	0.0042	Ω
		V_{GS} = 4.5 V, I_D = 22 A		0.0047	0.0057	
Forward Transconductance[a]	g_{fs}	V_{DS} = 15 V, I_D = 25 A		85		S
Diode Forward Voltage[a]	V_{SD}	I_S = 4.5 A, V_{GS} = 0 V		0.75	1.2	V
Dynamic[b]						
Input Capacitance	C_{iss}	V_{DS} = 15 V, V_{SS} = 0 V, f = 1 Hz		3775		pF
Output Capacitance	C_{oss}			630		
Reverse Transfer Capacitance	C_{rss}			295		
Total Gate Charge	Q_g	V_{DS} = 15 V, V_{GS} = 4.5 V, I_D = 25 A		27	40	nC
Gate-Source Charge	Q_{gs}			11.4		
Gate-Drain Charge	Q_{gd}			8.1		
Gate Resistance	R_g		0.5	1.2	2.0	Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = 15 V, R_L = 15 Ω $I_D \cong$ 1 A, V_{GEN} = 10 V, R_G = 6 Ω		20	30	ns
Rise Time	t_r			13	20	
Turn-Off Delay Time	$t_{d(off)}$			62	100	
Fall Time	t_f			20	35	
Source-Drain Reverse Recovery	t_{rr}	I_F = 2.9 A, di/dt = 100 A/µs		40	60	
Reverse Recovery Charge	Q_{rr}			40	60	nC

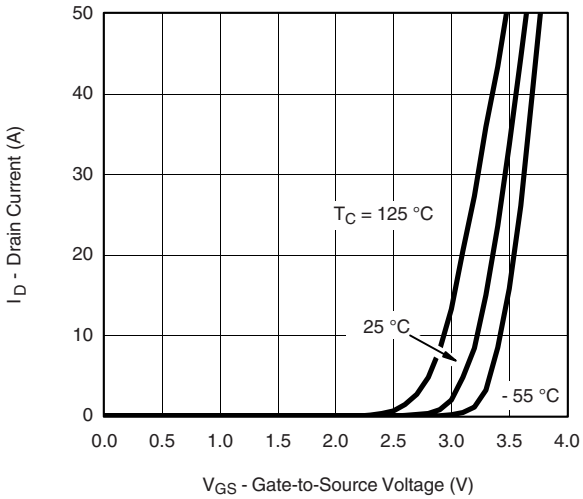
Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

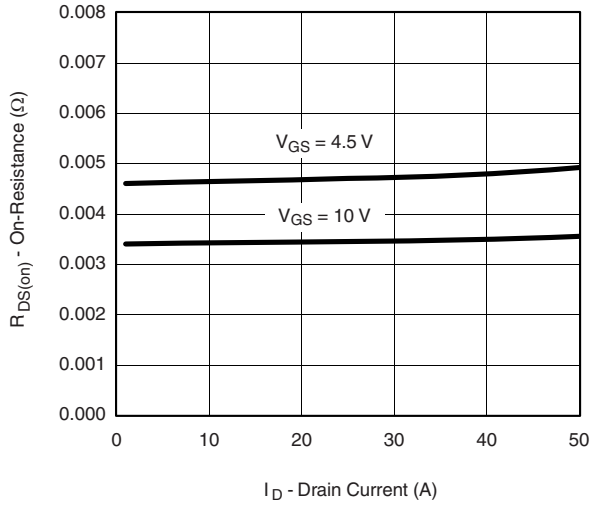


Output Characteristics

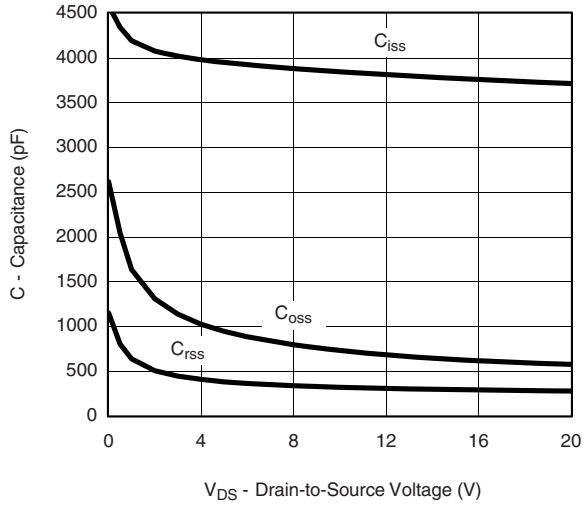


Transfer Characteristics

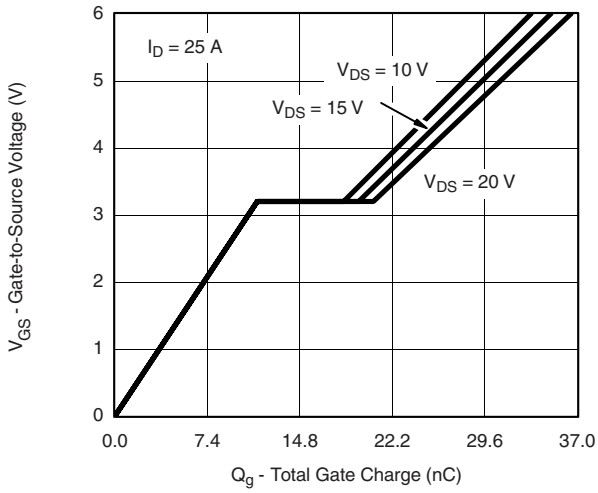
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



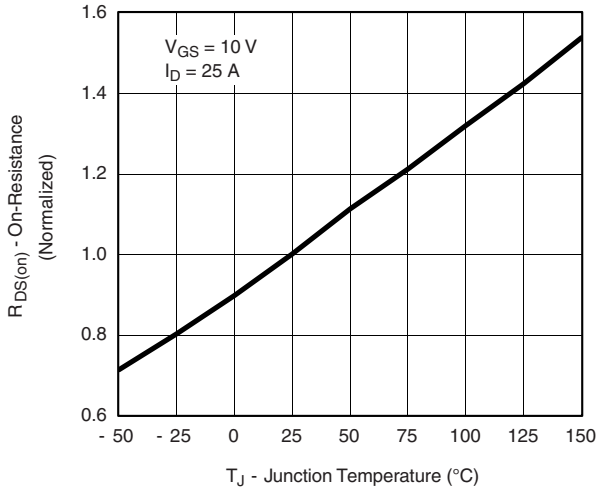
On-Resistance vs. Drain Current



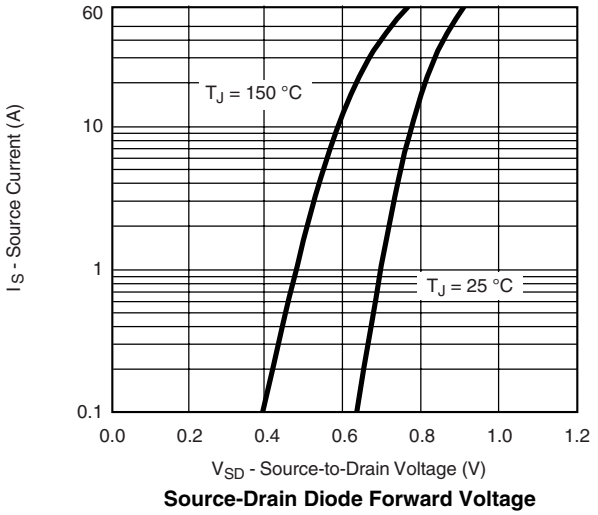
Capacitance



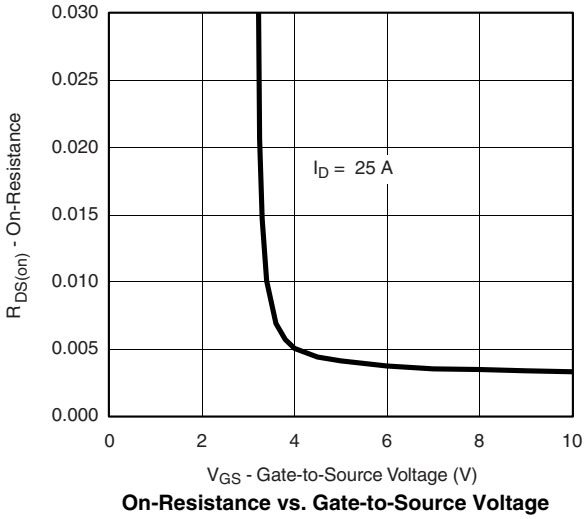
Gate Charge



On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

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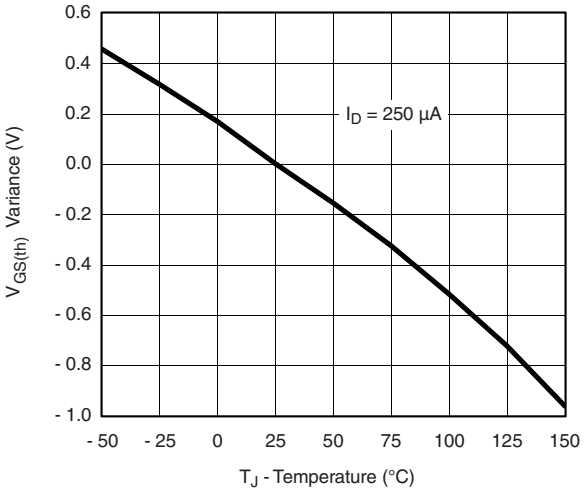
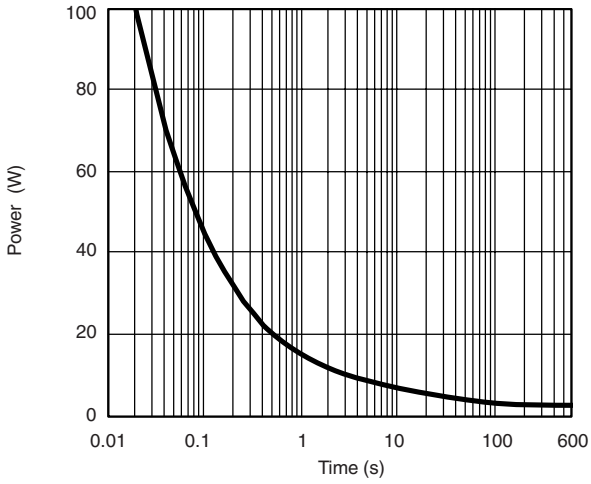
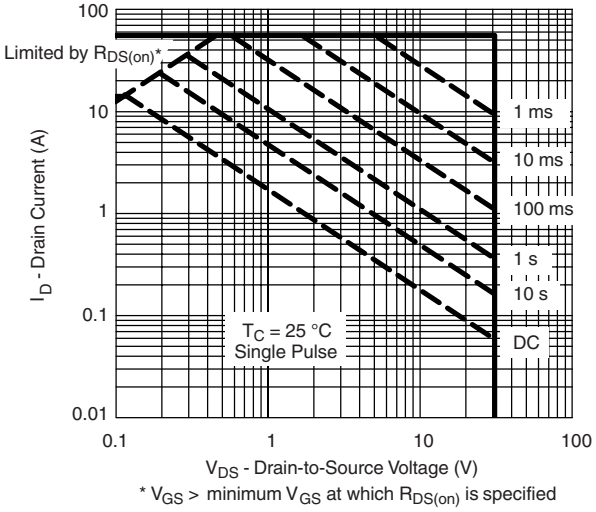


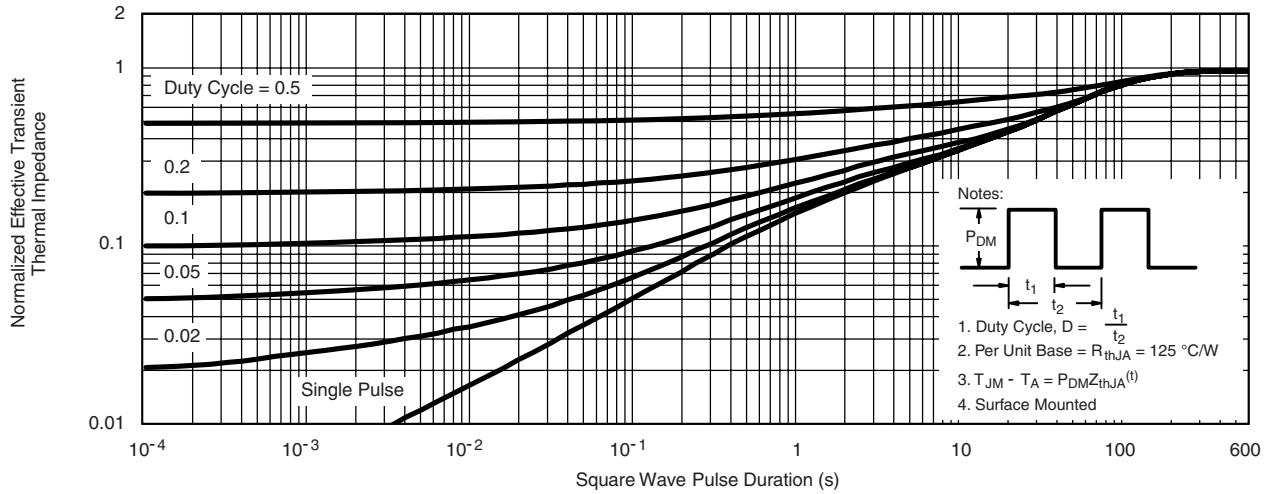
Threshold Voltage



Single Pulse Power

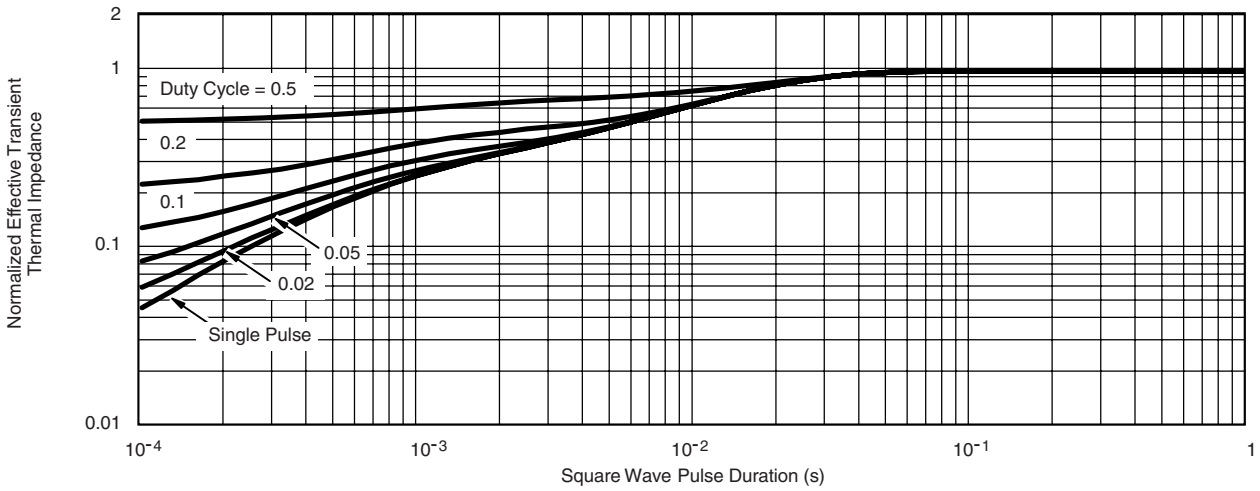


Safe Operating Area, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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